NEC

MOS FIELD EFFECT TRANSISTOR
2SK3740

SWITCHING
N-CHANNEL POWER MOS FET

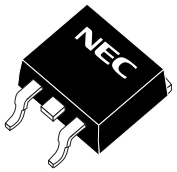
DESCRIPTION

The 2SK3740 is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, designed for high voltage applications such as lamp drive, DC/DC converter, and actuator driver.

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3740-ZK	TO-263 (MP-25ZK)

(TO-263)



FEATURES

- Gate voltage rating: ±30 V
- Low on-state resistance
  $R_{DS(on)}$ = 160 mΩ MAX. (V_{GS} = 10 V, I_D = 10 A)
- Low gate charge
  Q_G = 47 nC TYP. (V_{DD} = 200 V, V_{GS} = 10 V, I_D = 20 A)
- Surface mount package available

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Drain to Source Voltage (V_{GS} = 0 V)	V_{DSS}	250	V
Gate to Source Voltage (V_{DS} = 0 V)	V_{GSS}	±30	V
Drain Current (DC) (T_C = 25°C)	$I_{D(DC)}$	±20	A
Drain Current (pulse) Note1	$I_{D(pulse)}$	±60	A
Total Power Dissipation	P_{T1}	1.5	W
Total Power Dissipation (T_C = 25°C)	P_{T2}	100	W
Channel Temperature	T_{ch}	150	°C
Storage Temperature	T_{stg}	–55 to +150	°C
Single Avalanche Current Note2	I_{AS}	20	A
Single Avalanche Energy Note2	E_{AS}	40	mJ

Notes 1. PW ≤ 10 μs, Duty Cycle ≤ 1%

2. Starting T_{ch} = 25°C, V_{DD} = 125 V, R_G = 25 Ω, V_{GS} = 20 → 0 V, L = 100 μH

THERMAL RESISTANCE

Channel to Case Thermal Resistance	$R_{th(ch-C)}$	1.25	°C/W
Channel to Ambient Thermal Resistance	$R_{th(ch-A)}$	83.3	°C/W

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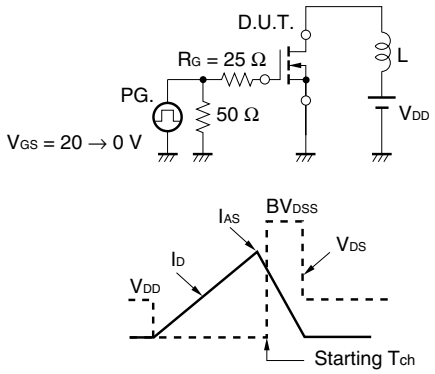
ELECTRICAL CHARACTERISTICS (T_A = 25°C)

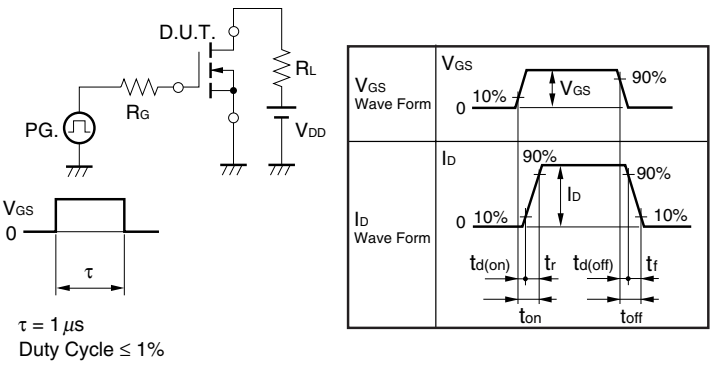
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 250 V, V_{GS} = 0 V			10	μA
Gate Leakage Current	I_{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V			±10	μA
Gate Cut-off Voltage	$V_{GS(off)}$	V_{DS} = 10 V, I_D = 1.0 mA	2.5	3.5	4.5	V
Forward Transfer Admittance **Note**	$\|y_{fs}\|$	V_{DS} = 10 V, I_D = 10 A	7.0	15		S
Drain to Source On-state Resistance **Note**	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 10 A		0.12	0.16	Ω
Input Capacitance	C_{iss}	V_{DS} = 10 V		1720		pF
Output Capacitance	C_{oss}	V_{GS} = 0 V		330		pF
Reverse Transfer Capacitance	C_{rss}	f = 1.0 MHz		170		pF
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = 125 V, I_D = 10 A		17		ns
Rise Time	t_r	V_{GS} = 10 V		17		ns
Turn-off Delay Time	$t_{d(off)}$	R_G = 0 Ω		49		ns
Fall Time	t_f			9		ns
Total Gate Charge	Q_G	V_{DD} = 200 V		47		nC
Gate to Source Charge	Q_{GS}	V_{GS} = 10 V		7		nC
Gate to Drain Charge	Q_{GD}	I_D = 20 A		25		nC
Body Diode Forward Voltage **Note**	$V_{F(S-D)}$	I_F = 20 A, V_{GS} = 0 V		0.91		V
Reverse Recovery Time	t_{rr}	I_F = 20 A, V_{GS} = 0 V		210		ns
Reverse Recovery Charge	Q_{rr}	di/dt = 100 A/μs		1.4		μC

Note Pulsed

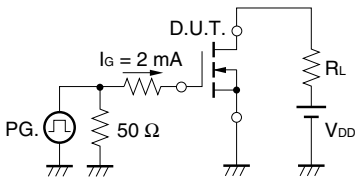
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME

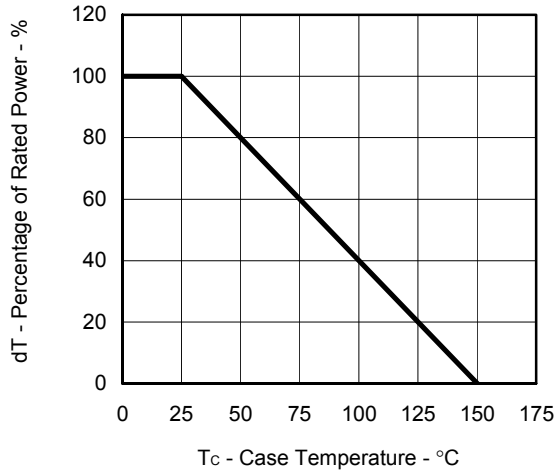


TEST CIRCUIT 3 GATE CHARGE

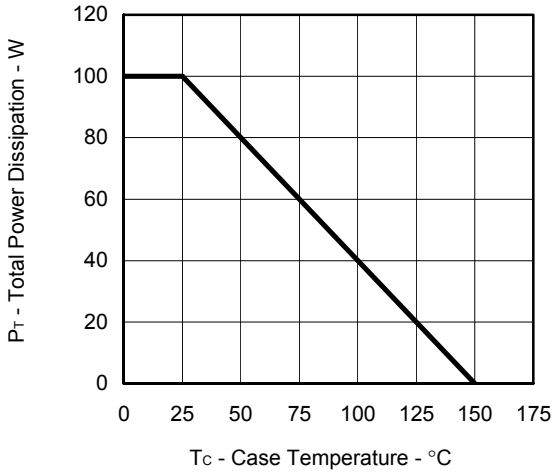


TYPICAL CHARACTERISTICS (T_A = 25°C)

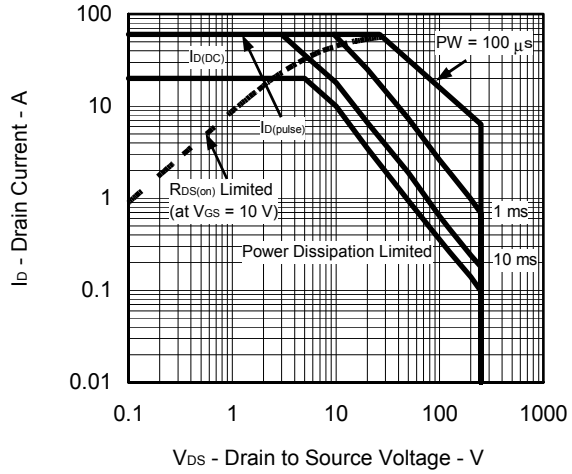
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



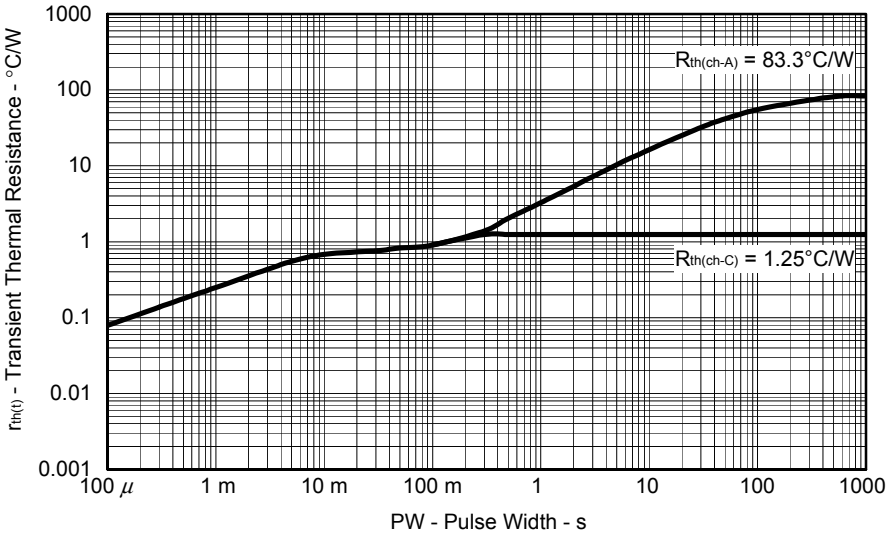
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



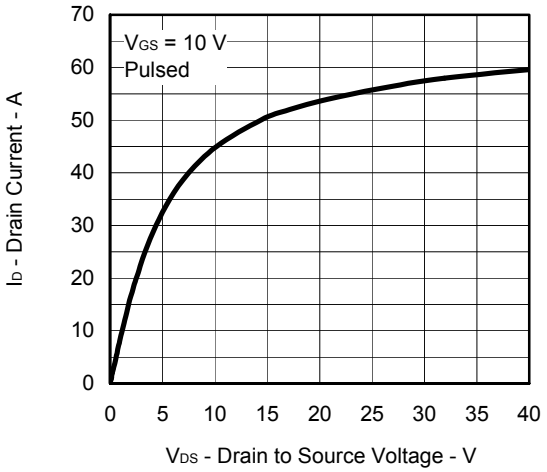
FORWARD BIAS SAFE OPERATING AREA



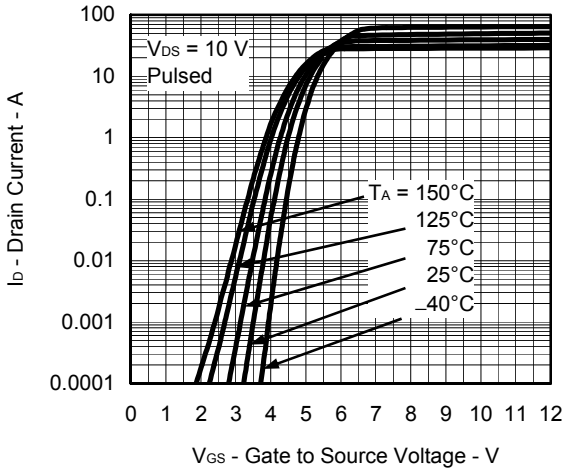
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



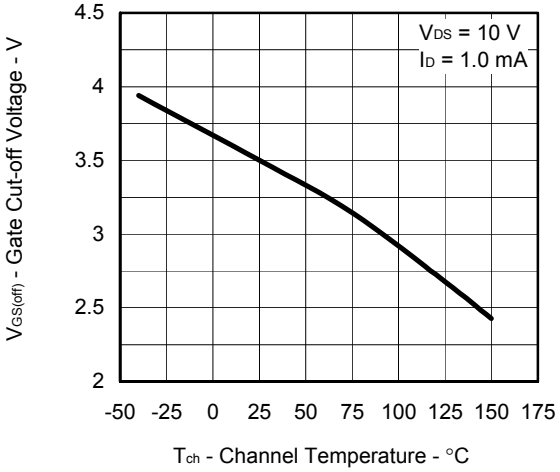
DRAIN CURRENT vs.
DRAIN TO SOURCE VOLTAGE



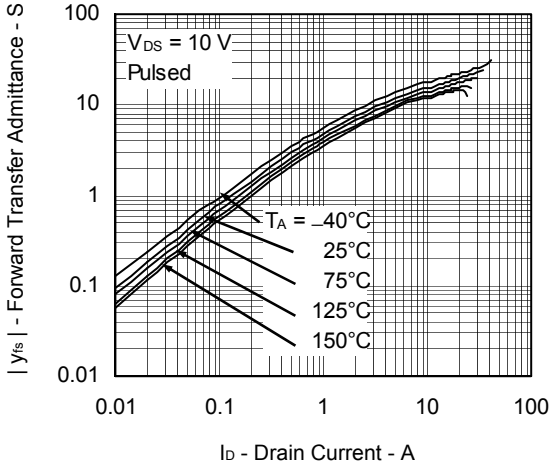
FORWARD TRANSFER CHARACTERISTICS



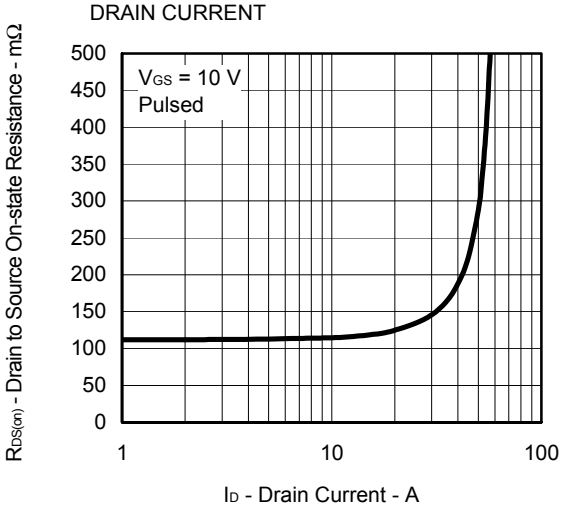
GATE CUT-OFF VOLTAGE vs.
CHANNEL TEMPERATURE



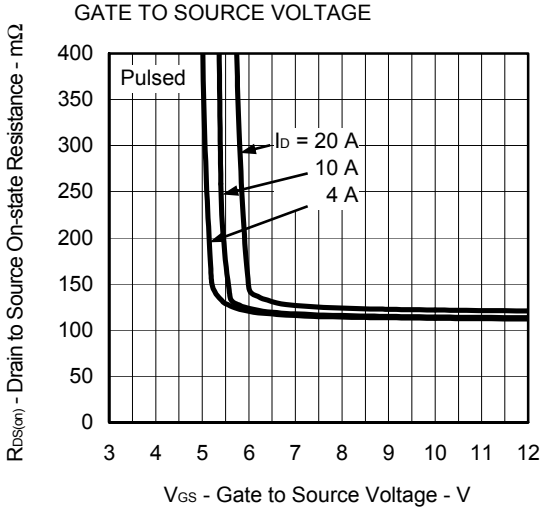
FORWARD TRANSFER ADMITTANCE vs.
DRAIN CURRENT



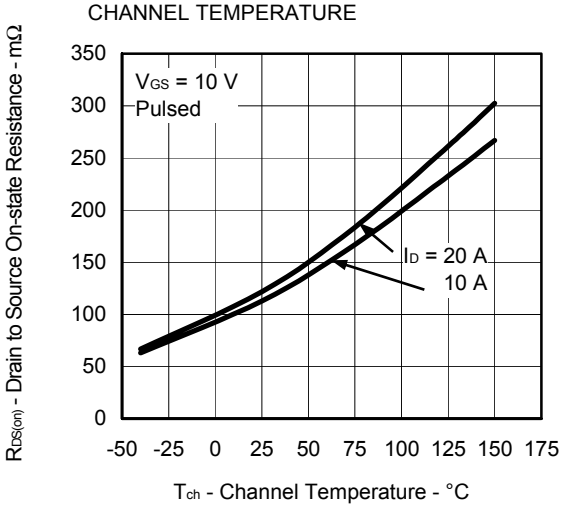
DRAIN TO SOURCE ON-STATE RESISTANCE vs.
DRAIN CURRENT



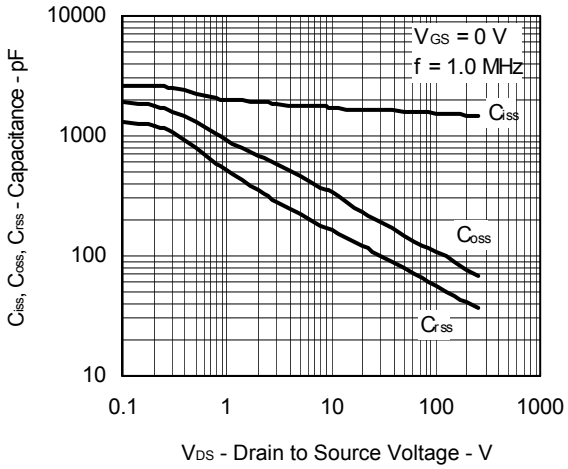
DRAIN TO SOURCE ON-STATE RESISTANCE vs.
GATE TO SOURCE VOLTAGE



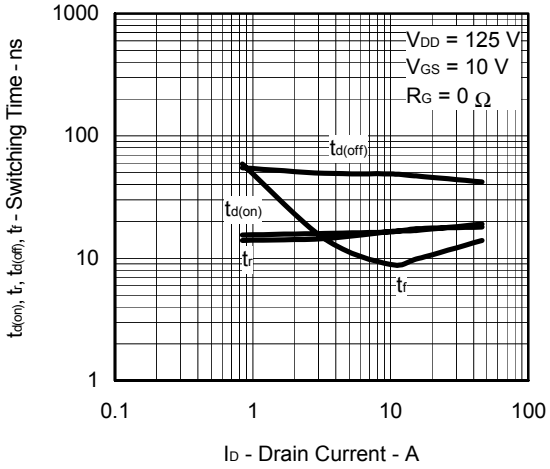
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



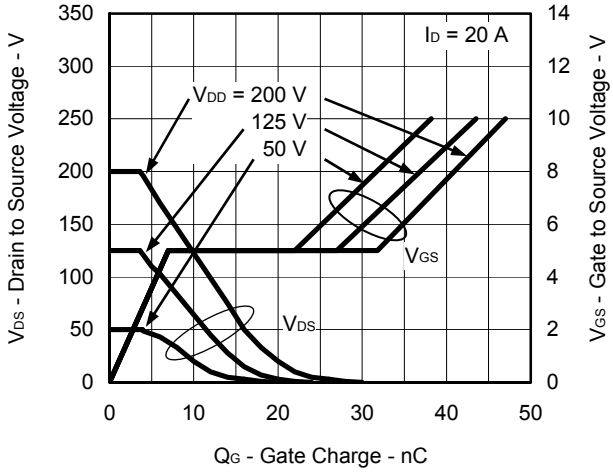
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



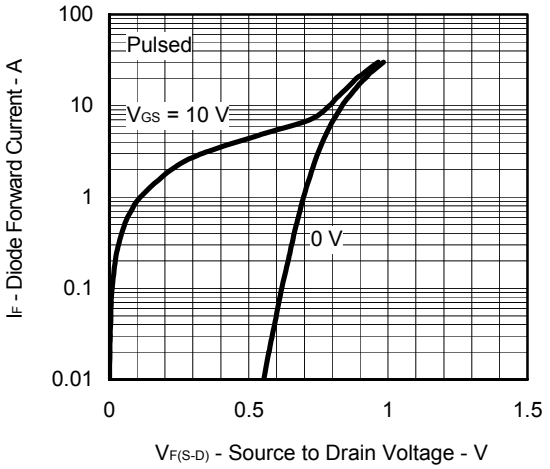
SWITCHING CHARACTERISTICS



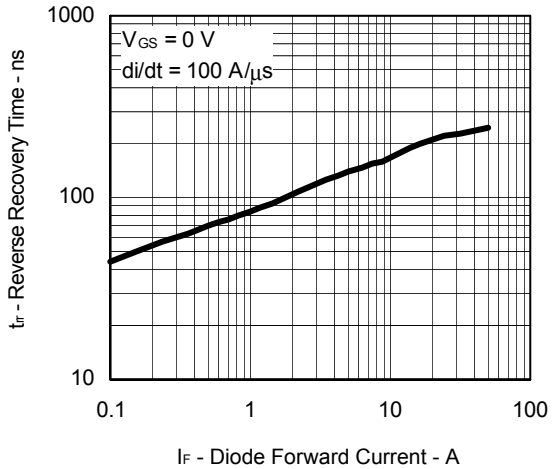
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



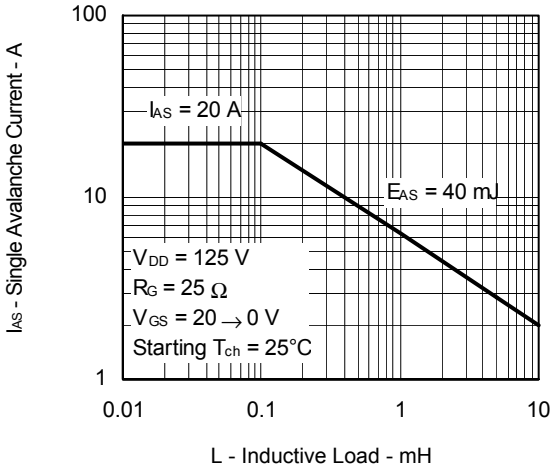
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



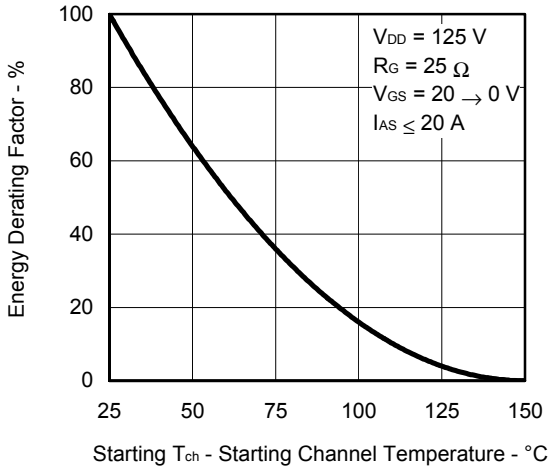
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



SINGLE AVALANCHE CURRENT vs.
INDUCTIVE LOAD

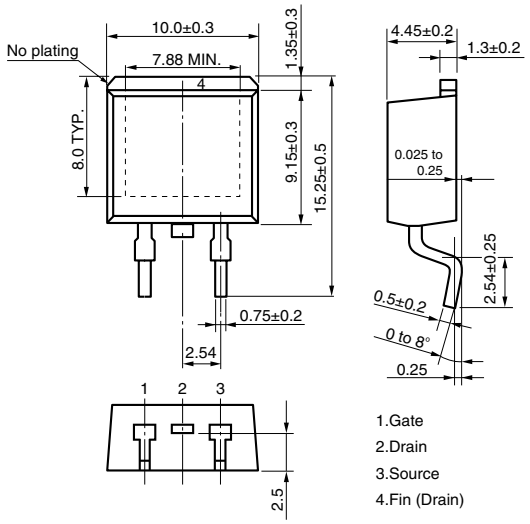


SINGLE AVALANCHE ENERGY
DERATING FACTOR

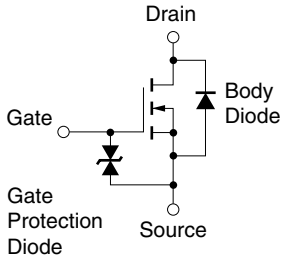


PACKAGE DRAWING (Unit: mm)

TO-263 (MP-25ZK)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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